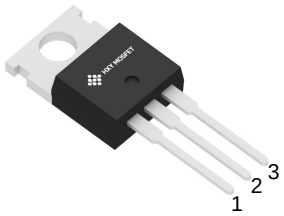
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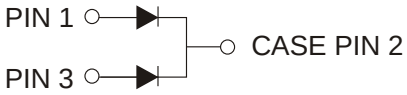
Schottky Rectifier Diodes

Features

- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Solder dip 275 °C max. 7 s, per JESD 22-B106



TO-220C(TO-220AB-3)



Maximum Ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	Unit	Limit
Repetitive Peak Reverse Voltage	V_{RRM}	V	100
Average Rectified Output Current @60Hz sine wave, R-load, T_a=25°C	I_O	A	30
Surge(Non-repetitive)Forward Current @60Hz half sine-wave, 1 cycle, T_a=25°C	I_{FSM}	A	250
Current Squared Time @1ms≤t<8.3ms Tj=25°C	I^2t	A^2s	176
Storage Temperature	T_{stg}	°C	-55 ~ +175
Junction Temperature	T_j	°C	-55 ~ +175

Electrical Characteristics(Ta=25°C unless otherwise specified)

Parameter	Symbol	Unit	Test Conditions	Limit
Maximum instantaneous forward voltage drop per diode	V_{FM}	V	I_{FM}=15.0A	0.8
Maximum DC reverse current at rated DC blocking voltage per diode	I_{RRM1}	mA	V_{RM}=V_{RRM} T_a=25℃	0.1
	I_{RRM2}		V_{RM}=V_{RRM} T_a=125℃	20

Typical Characteristics

FIG1:Io -Tc Curve

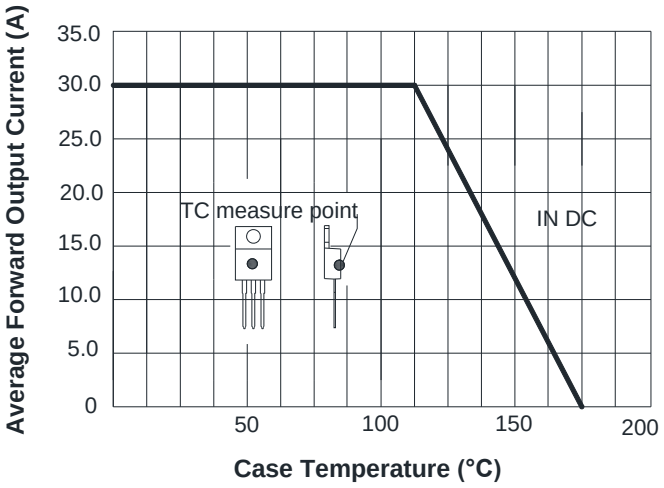


FIG2:Surge Forward Current Capability

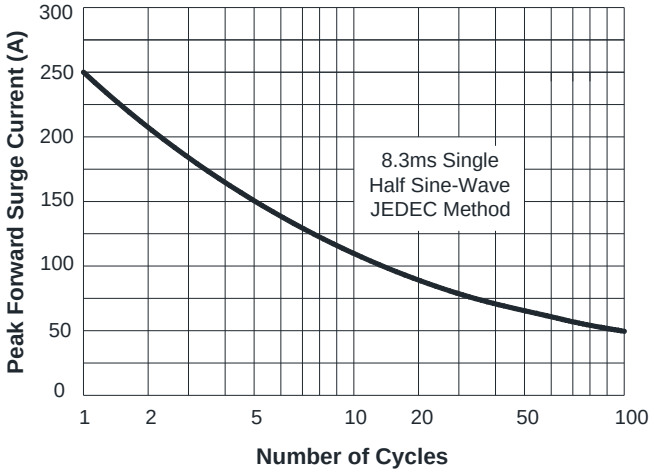


FIG3: Forward Voltage

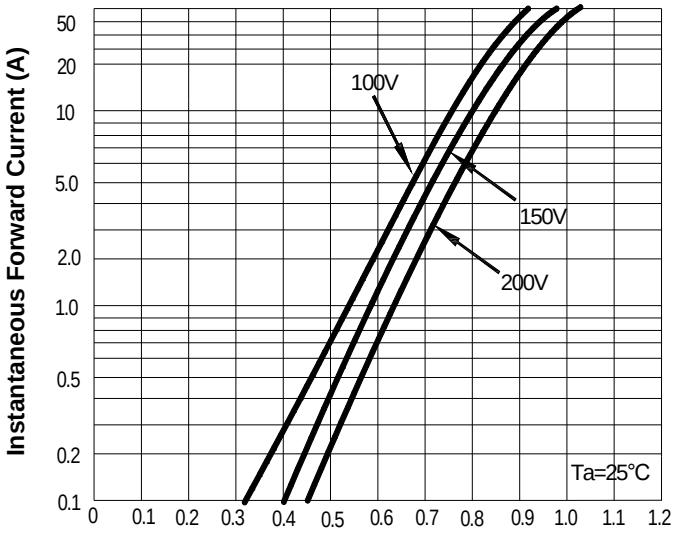
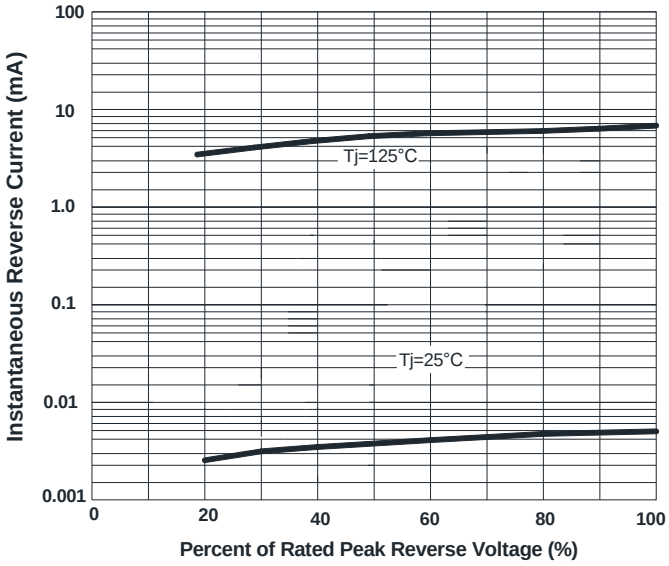
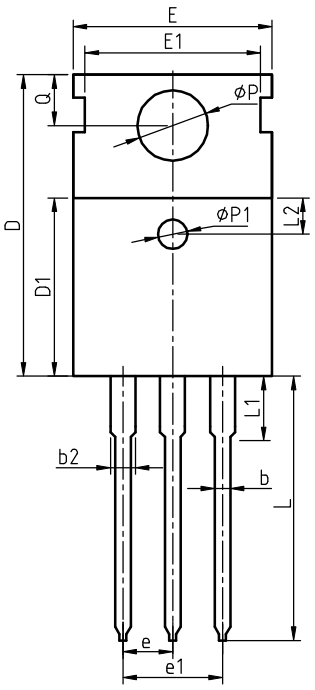
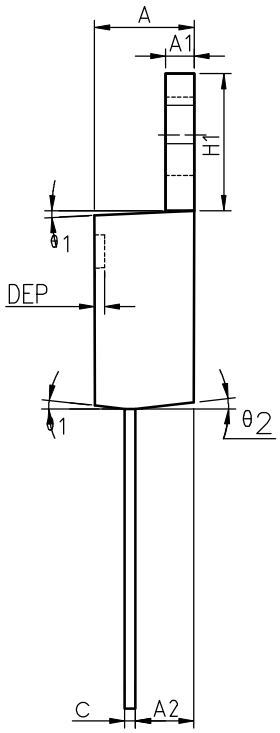


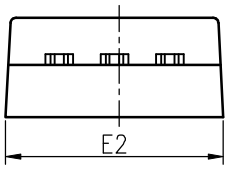
FIG.4: Instantaneous Reverse Characteristics



Package Information
TO-220C(TO-220AB-3)







COMMON DIMENSIONS

SYMBOL	MIN	NOM	MAX	MIN	NOM	MAX
A	4.40	4.57	4.70	0.173	0.180	0.185
A1	1.27	1.30	1.33	0.050	0.051	0.052
A2	2.35	2.40	2.50	0.093	0.094	0.098
b	0.77	0.80	0.90	0.030	0.031	0.035
b2	1.17	1.27	1.36	0.046	0.050	0.054
c	0.48	0.50	0.56	0.019	0.020	0.022
D	15.40	15.60	15.80	0.606	0.614	0.622
D1	9.00	9.10	9.20	0.354	0.358	0.362
DEP	0.05	0.10	0.20	0.002	0.004	0.008
E	9.80	10.00	10.20	0.386	0.394	0.402
E1	-	8.70	-	-	0.343	-
E2	9.80	10.00	10.20	0.386	0.394	0.402
e		2.54	BSC		0.100	BSC
e1		5.08	BSC		0.200	BSC
H1	6.40	6.50	6.60	0.252	0.256	0.260
L	12.75	13.50	13.65	0.502	0.531	0.537
L1	-	3.10	3.30	-	0.122	0.130
L2		2.50	REF		0.098	REF
P	3.50	3.60	3.63	0.138	0.142	0.143
P1	3.50	3.60	3.63	0.138	0.142	0.143
Q	2.73	2.80	2.87	0.107	0.110	0.113
θ1	5°	7°	9°	5°	7°	9°
θ2	1°	3°	5°	1°	3°	5°
θ3	1°	3°	5°	1°	3°	5°

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